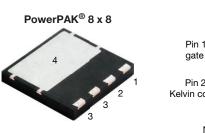
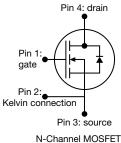
SiHH068N60E

Vishay Siliconix



E Series Power MOSFET





PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.059		
Q _g max. (nC)	80			
Q _{gs} (nC)	17			
Q _{gd} (nC)	20			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	PowerPAK 8 x 8		
Lead (Pb)-free and halogen-free	SiHH068N60E-T1-GE3		

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	600	v	
Gate-source voltage			± 30	v	
Continuous drain current (T _J = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		34		
	V_{GS} at 10 V $T_C = 100 $ °C	; I _D	22	А	
Pulsed drain current ^a	I _{DM}	100			
Linear derating factor			1.6	W/°C	
Single pulse avalanche energy ^b		E _{AS}	226	mJ	
Maximum power dissipation	PD	202	W		
Operating junction and storage temperature rar	nge	T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C	; dv/dt	70	V/ns	
Reverse diode dv/dt ^c		uv/ut	50	v/IIS	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.0 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	38 50			2 0 AN			
Maximum junction-to-case (drain)	R _{thJC}	0.48 0.62				°C/W		
SPECIFICATIONS ($T_J = 25 \degree C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static						I	1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.56	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara anto valtano ducio comunit		V _{DS} =	= 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 V	′, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	₀ = 15 A	-	0.059	0.068	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D =	= 15 A	-	9.3	-	S
Dynamic		•			•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2650	-	-	
Output capacitance	C _{oss}			-	113	-		
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 480 V, $V_{\rm GS}$ = 0 V		-	94	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	591	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	53	80	nC	
Gate-source charge	Q _{gs}			-	17	-		
Gate-drain charge	Q _{gd}				-	20	-	1
Turn-on delay time	t _{d(on)}		•		-	56	84	
Rise time	t _r	V _{DD} =	= 480 V, I _D =	= 15 A,	-	148	222	
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	60	90	- ns	
Fall time	t _f			-	30	60		
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	34		
Pulsed diode forward current	I _{SM}			-	-	100	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	T _J = 25 °C, $I_F = I_S = 15 \text{ A}$, di/dt = 100 A/µs, $V_B = 25 \text{ V}$		-	377	754	ns	
Reverse recovery charge	Q _{rr}			-	5.7	11.4	μC	
Reverse recovery current	I _{RRM}		100 Ανμο, Ν	rr - 23 v	-	25	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

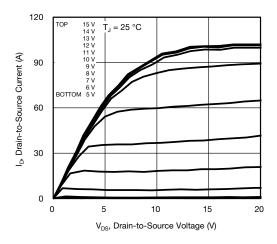


Fig. 1 - Typical Output Characteristics

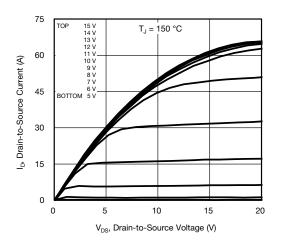


Fig. 2 - Typical Output Characteristics

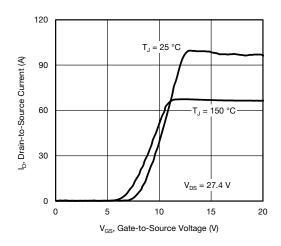


Fig. 3 - Typical Transfer Characteristics

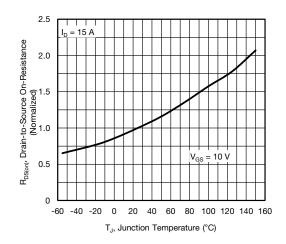


Fig. 4 - Normalized On-Resistance vs. Temperature

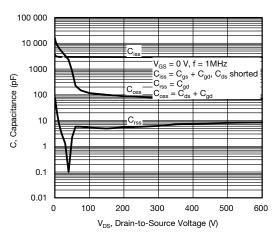
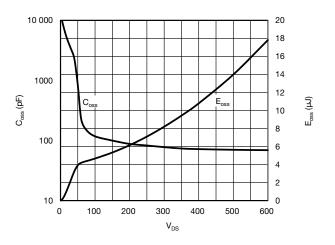
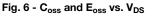


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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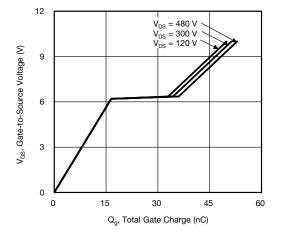


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

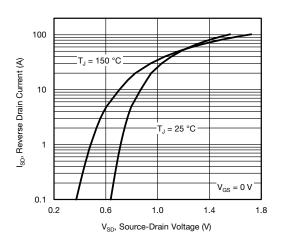
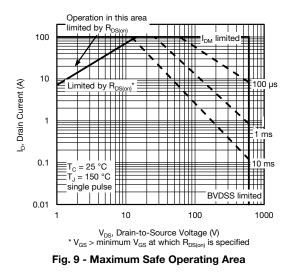


Fig. 8 - Typical Source-Drain Diode Forward Voltage



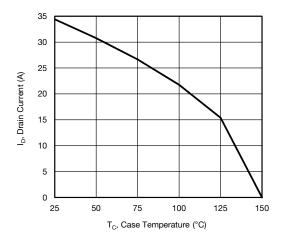


Fig. 10 - Maximum Drain Current vs. Case Temperature

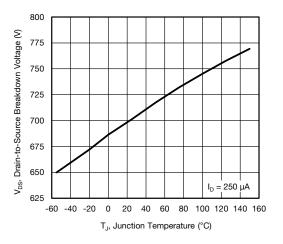


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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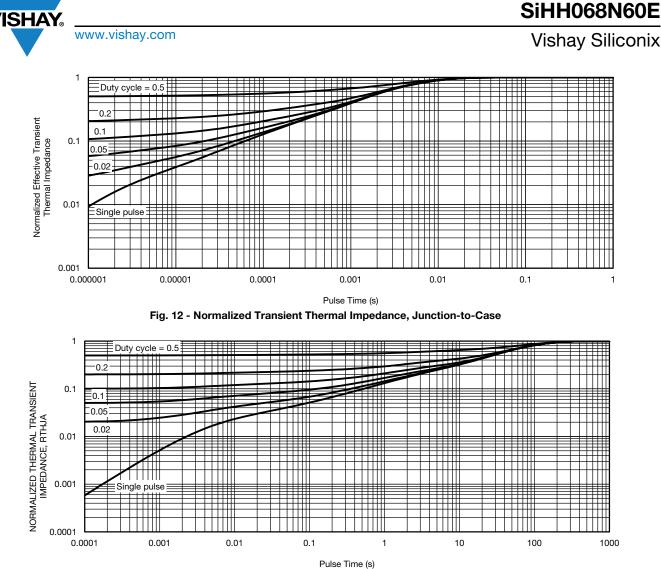


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

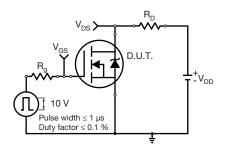
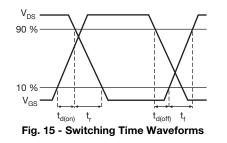


Fig. 14 - Switching Time Test Circuit



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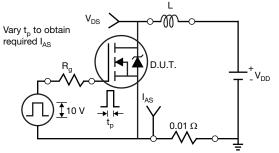


Fig. 16 - Unclamped Inductive Test Circuit

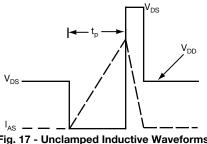
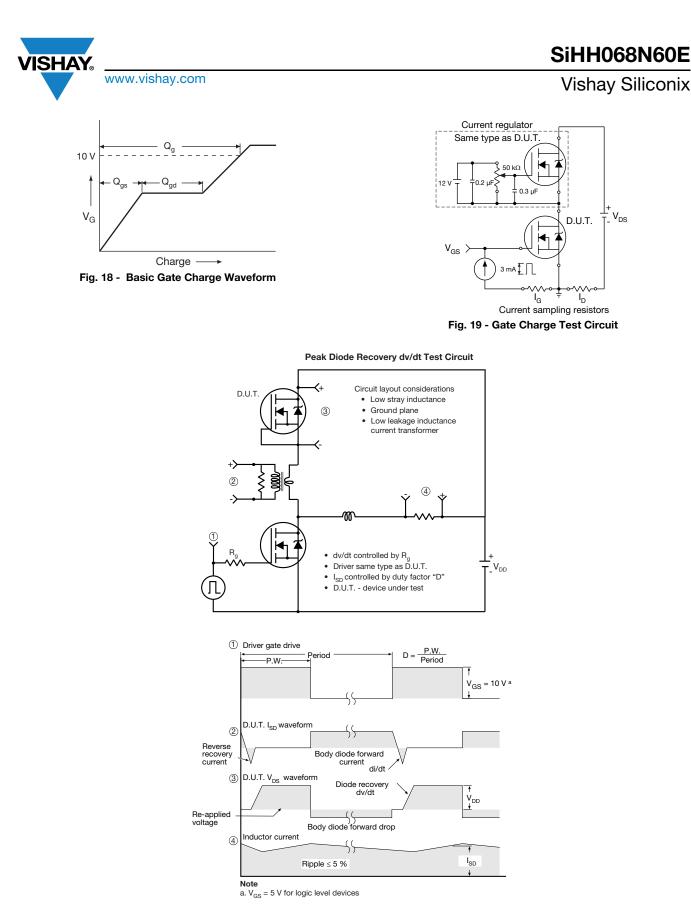


Fig. 17 - Unclamped Inductive Waveforms

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